ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES® International and Pa	IPC. Bannock	burn, Illinois, A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declaration en declaration	on of the su	bstances v all lower	vithin the manufactu level materials for v	urer listed which the	item. Note: manufactur	if the item is an as er has engineering	ssembly with low responsibility.	
				Form Type Distribute	 Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg 					Afg Informa	ation			
Supplier Information														
Company name* Compa			mpany unique ID			Unique ID Authority				Respon	Response Date*			
onsemi										2024-0	2024-05-18			
Contact Name Title - Contact			et			Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards Product Env			viro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repre			esentative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Product En			nviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	er Mfr Item Nu		Number Mfr Item Name			Effective Date Version Manufacturing		Ianufacturing Site		Weight*	UOM	Unit Type		
	S3DB	3DB SR SMB GPP		N 3A 200V		2024-05-18		T	TSCBE		92.0	mg	Each	
Ianufacturing Proccess Inform	ation		•			•								
Terminal Plating / Grid Array M	Iaterial	Ferminal Base A	Alloy	y J-STD-020 MSL Rati		Peak Proce	rocess Body Temperature M		e Max Time at Peal	k Tempera	ature Nun	nber of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30	seco	nds 3			
omments														
vel 1 - maximum time at peak tempera	ture during so	dering is 10-3	0 seconds											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chro	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.764	mg	Supplier	Silicon (Si)	7440-21-3		0.7585	mg
			В	Nickel (Ni)	7440-02-0		0.0011	mg
			Supplier	Gold (Au)	7440-57-5		0.0042	mg
			В	Arsenic (As)	7440-38-2		0.0002	mg
Die Attach Solder	2.25	mg	Supplier	Silver (Ag)	7440-22-4		0.0563	mg
			А	Lead (Pb)	7439-92-1	7a	2.0812	mg
			Supplier	Tin (Sn)	7440-31-5		0.1125	mg
Lead Frame	34.0437	mg	Supplier	Iron (Fe)	7439-89-6		0.0409	mg
			Supplier	Copper (Cu)	7440-50-8		33.9926	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0102	mg
Mold Compound-Black	54.234	mg		Metal Hydroxide	proprietary data		1.8982	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		4.3387	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2712	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		43.3872	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		4.3387	mg
Plating	0.7083	mg	Supplier	Tin (Sn)	7440-31-5		0.7083	mg